Electronic Supplementary Material (ESI)

Heat and pressure-resistant room temperature irreversible sealing of hybrid PDMS-thermoplastic microfluidic devices *via* carbon-nitrogen covalent bonding and its application for continuous-flow polymerase chain reaction

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Fig. S1 Photos showing the reaction progress between the ECTMS coated PDMS and APTES coated PC with the lapse of time.



Fig. S2 A photo of the temperature controller used for performing on-chip CF-PCR.



Fig. S3 A schematic illustration of the serpentine microchannel of the PDMS–PC microfluidic device used for 30 thermal cycles for CF-PCR.



Fig. S4 High resolution XPS spectra for PDMS. (a) C1s, (b) O1s, (c) Si2p and (d) survey spectrum.



Fig. S5 High resolution XPS spectra for ECTMS modified PDMS. (a) C1s, (b) O1s, (c) Si2p and (d) survey spectrum.



Fig. S6 Results of delamination test.



Fig. S7 A schematic illustration of the PDMS–PC microfluidic device placed on two copper heaters for controlling the temperature for CF-PCR. Red and green colors represent denaturation and annealing/extension zones, respectively. "A" is a length value.



Fig. S8 The IR camera images showing the time-dependent temperatures of the surface of the PC substrate at 0, 5, 15, 30, 45, 60, 90, and 120 min after applying the heat from two copper heat blocks.

Bonding substrates	Bonding strength (kPa)	Silane reagent	Bonding time	Ref
PDMS-PMMA	274.5			
PDMS-PS	591.7	1 wt% APTMS	30 min	This work
PDMS-PC	594.7	and ECTMS	50 1111	
PDMS-PET	510.0			
PDMS-PMMA	180			Lah Chin 2010
PDMS-PC	178	and GPTMS	1 h	10 . 1274–1280
PDMS-PMMA	305.8			
PDMS-PC	219.7		45 1	Appl. Surf. Sci.,
PDMS-PET	189.0	5 WT% APTIMS	15 min	2015, 327 ,233– 240
PDMS-PS	475.7			
PDMS-PC	430			
PDMS-COC	432		45 1	Lab Chip, 2011,
PDMS-PMMA	385	1 Wt% APTMS	15 min	11 , 962–965
PDMS-PS	388			

Table S1 Comparison of the bonding strengths